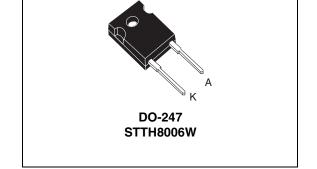


# **STTH8006**

## Turbo 2 ultrafast high voltage rectifier

## Main product characteristics

| I <sub>F(AV)</sub>    | 80 A   |
|-----------------------|--------|
| V <sub>RRM</sub>      | 600 V  |
| Tj                    | 175 °C |
| V <sub>F</sub> (typ)  | 1.02 V |
| t <sub>rr</sub> (max) | 70 ns  |



## **Features and benefits**

- Ultrafast switching
- Low reverse current
- Low thermal resistance
- Reduces switching and conduction losses

## **Description**

The STTH8006, which is using ST Turbo 2 600V technology, is specially suited for use in switching power supplies, and industrial applications, as rectification and discontinuous mode PFC boost diode. Thanks to its low  $V_{\rm F}$  characteristics, this device exhibits high performances in freewheeling applications.

### **Order Code**

| Part number | Marking   |
|-------------|-----------|
| STTH8006W   | STTH8006W |

Table 1. Absolute ratings (limiting values, at  $T_{amb}$  = 25 °C, unless otherwise specified)

| Symbol              | Parameter                              |  | Value        | Unit |
|---------------------|--|--|--------------|------|
| V <sub>RRM</sub>    | Repetitive peak reverse voltage        |  | 600          | V    |
| I <sub>F(RMS)</sub> | RMS forward voltage                    |  | 113          | Α    |
| I <sub>F(AV)</sub>  | Average forward current                | $T_c = 75 ^{\circ}\text{C}$ $\delta = 0.5$ | 80           | Α    |
| I <sub>FSM</sub>    | Surge non repetitive forward current   | t <sub>p</sub> = 10 ms sinusoidal          | 500          | Α    |
| T <sub>stg</sub>    | Storage temperature range              |  | -65 to + 175 | °C   |
| T <sub>j</sub>      | Maximum operating junction temperature |  | 175          | °C   |

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Characteristics STTH8006

#### 1 **Characteristics**

Table 2. Thermal resistance

| Symbol               | Parameter        | Value (max). | Unit |
|----------------------|------------------|--------------|------|
| R <sub>th(j-c)</sub> | Junction to case | 0.75         | °C/W |

Table 3. Static electrical characteristics

| Symbol   | Parameter               | Test conditions         |                       | Min. | Тур  | Max. | Unit |
|--|-------------------------|-------------------------|-----------------------|------|------|------|------|
| I <sub>B</sub> <sup>(1)</sup>                      | Reverse leakage current | T <sub>j</sub> = 25 °C  | V - V                 |      |      | 50   | μA   |
| 'R`  | neverse leakage current | T <sub>j</sub> = 150 °C | $V_R = V_{RRM}$       |      | 160  | 1600 | μΑ   |
| V <sub>E</sub> <sup>(2)</sup>                      | Forward voltage drop    | T <sub>j</sub> = 25 °C  | I <sub>F</sub> = 80 A |      |      | 1.60 | V    |
| V <sub>F</sub> <sup>(2)</sup> Forward voltage drop | T <sub>i</sub> = 150 °C | I <sub>F</sub> = 60 A   | IF = 00 A             | 1.02 | 1.30 | V    |      |

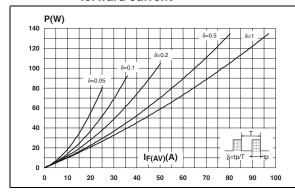
<sup>1.</sup> Pulse test:  $t_p$  = 5 ms,  $\delta$  < 2 %

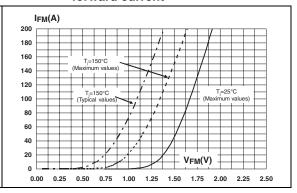
To evaluate the conduction losses use the following equation: P = 0.98 x  $I_{F(AV)}$  + 0.004  $I_{F}{}^{2}_{(RMS)}$ 

**Dynamic characterstics** Table 4.

| Symbol          | Parameter                | Test conditions        |  | Min. | Тур | Max. | Unit |
|-----------------|--------------------------|------------------------|--|------|-----|------|------|
| +               | Reverse recovery         | T <sub>i</sub> = 25°C  | I <sub>F</sub> = 0.5 A Irr = 0.25 A I <sub>R</sub> =1 A  |      |     | 70   | ns   |
| t <sub>rr</sub> | time                     | 1                      | $I_F = 1 \text{ A} \text{ d}I_F/\text{d}t = 50 \text{ A/}\mu\text{s} \text{ V}_R = 30 \text{ V}$ |      | 75  | 105  | 113  |
| I <sub>RM</sub> | Reverse recovery current | T <sub>j</sub> = 125°C | $I_F = 80 \text{ A}$ $V_R = 400 \text{ V}$ $dI_F/dt = 100 \text{ A}/\mu\text{s}$                 |      | 14  | 19   | Α    |
| t <sub>fr</sub> | Forward recovery time    | T <sub>j</sub> = 25°C  | $I_F = 80 \text{ A}$ $dI_F/dt = 200 \text{ A/}\mu\text{s}$ $V_{FR} = 1.1 \text{ x } V_{Fmax}$    |      |     | 600  | ns   |
| V <sub>FP</sub> | Forward recovery voltage | T <sub>j</sub> = 25°C  | $I_F = 80 \text{ A}$ $dI_F/dt = 200 \text{ A/}\mu\text{s}$ $V_{FR} = 1.1 \text{ x } V_{Fmax}$    |      | 3.7 |      | V    |

Conduction losses versus average Figure 2. Forward voltage drop versus forward current forward current



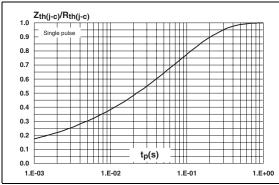


<sup>2.</sup> Pulse test:  $t_D$  = 380  $\mu$ s,  $\delta$  < 2 %

STTH8006 Characteristics

Figure 3. Relative variation of thermal impedance junction to case versus pulse duration

Figure 4. Peak reverse recovery current versus dl<sub>F</sub>/dt (typical values)



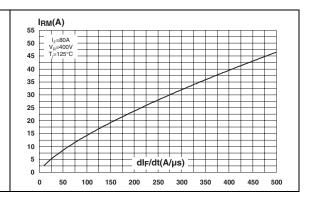
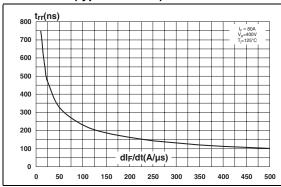


Figure 5. Reverse recovery time versus  $dI_F/dt$  Figure 6. Reverse recovery charges versus  $dI_F/dt$  (typical values)



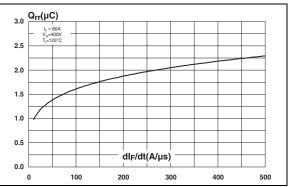
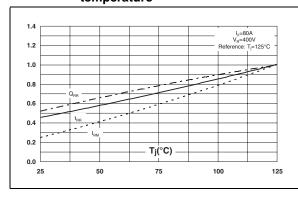
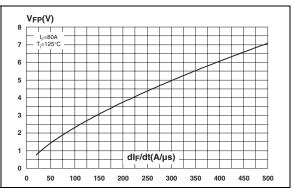


Figure 7. Relative variations of dynamic parameters versus junction temperature

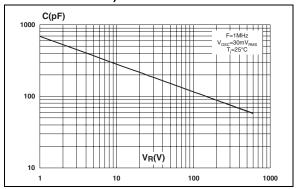
Figure 8. Transient peak forward voltage versus dl<sub>F</sub>/dt (typical values)





Package information STTH8006

Figure 9. Junction capacitance versus reverse voltage applied (typical values)



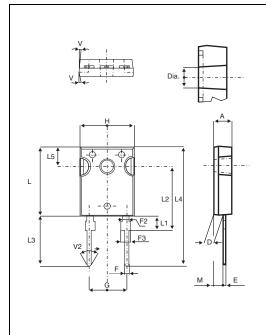
# 2 Package information

• Epoxy meets UL94, V0

Cooling method: by conduction (C)Recommended torque value: 0.8 Nm.

Maximum torque value: 1.0 Nm.

Table 5. DO-247 dimensions



|      |       | DIMENSIONS |       |       |        |       |  |
|------|-------|------------|-------|-------|--------|-------|--|
| REF  | Mi    | llimete    | rs    |       | Inches |       |  |
|      | Min   | Тур        | Max   | Min   | Тур    | Max   |  |
| Α    | 4.85  |            | 5.15  | 0.191 |        | 0.203 |  |
| D    | 2.20  |            | 2.60  | 0.086 |        | 0.102 |  |
| Е    | 0.40  |            | 0.80  | 0.015 |        | 0.031 |  |
| F    | 1.00  |            | 1.40  | 0.039 |        | 0.055 |  |
| F2   |       | 2.00       |       |       | 0.078  |       |  |
| F3   | 2.00  |            | 2.40  | 0.078 |        | 0.094 |  |
| G    |       | 10.90      |       |       | 0.429  |       |  |
| Н    | 15.45 |            | 15.75 | 0.608 |        | 0.620 |  |
| L    | 19.85 |            | 20.15 | 0.781 |        | 0.793 |  |
| L1   | 3.70  |            | 4.30  | 0.145 |        | 0.169 |  |
| L2   |       | 18.50      |       |       | 0.728  |       |  |
| L3   | 14.20 |            | 14.80 | 0.559 |        | 0.582 |  |
| L4   |       | 34.60      |       |       | 1.362  |       |  |
| L5   |       | 5.50       |       |       | 0.216  |       |  |
| М    | 2.00  |            | 3.00  | 0.078 |        | 0.118 |  |
| V    |       | 5°         |       |       | 5°     |       |  |
| V2   |       | 60°        |       |       | 60°    |       |  |
| Dia. | 3.55  |            | 3.65  | 0.139 |        | 0.143 |  |

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In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

## 3 Ordering information

| Part number | Marking   | Package | Weight | Base qty | Delivery mode |
|-------------|-----------|---------|--------|----------|---------------|
| STTH8006W   | STTH8006W | DO-247  | 4.40 g | 30       | Tube          |

## 4 Revision history

| Date        | Revision | Changes          |
|-------------|----------|------------------|
| 15-Dec-2006 | 1        | Initial release. |

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